02

SPECIFICATIONS

PRODUCT : LCD MODULE

MODEL NO. : S69509B-DD025MB

CUSTOMER NO.: DS11005199



深圳市宇顺电子股份有限公司

SUCCESS ELECTRONICS LTD

"Not to use the substances and their applications of SUCCESS Management Standard for Environment-related Substances to be Controlled "

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STANDARD DOC.	PRODUCT SPEC.	MODULE NO.	S69509B	-DD025MB	PA	GE	2 /2'
RECORDS OF REVISION							
DATE	REVISED NO.	REVISEI	DESCRIPTIONS	PREPARED	CHECKED	APPRO	VED
2021-12-9	01	New release		Xianggs	Zengzhaopeng	Wang	ζF
2022-2-18	02	Item 8.0:Update	e initial code	Xianggs	Zengzhaopeng	Wang	ΥF
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		SUCC	ESS ELECTRONIC				

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STANDARD DOC.	PRODUCT SPEC.	MODULE NO.	S69509B-DD025MB	PAGE	3 /27
		<u>C(</u>	DNTENTS	I	
1. GENERA	L SPECIFIC	ATIONS			4
2.BLOCK D	IAGRAM				5
3.OUTLINE	DRAWING	· · · · · · · · · · · · · · · · · · ·			6
4. INTERFA	CE ASSIGN	IMENT			7
5.APPLICA	TION CIRC	UIT			8
6. TIMING (CHARACTE	RISTICS			9
7. POWER (ON/OFF SEC	QUENCE			12
8. RECOMN	IENDED IN	ITIAL CODI	ES		14
9. INSTRUC	CTION TAB	LE			15
10.ELECTR	ICAL CHAF	RACTERIST	ICS		16
11. LED BA	CKLIGHT				17
12. OPTICA	L CHARAC	TERISTICS.			18
13. ENVIRC	ONMENTAL	ABSOLUTI	E MAXIMUM RATINGS		20
14. RELIAB	ILITY TEST				20
15. THE ST	ANDAND O	F INSPECTI	ON		21
16. USING I	LCD MODU	LES			24

SUCCESS	宇顺	I		1	
STANDARD DOC.	PRODUCT SPEC.	MODULE NO.	S69509B-DD025MB	PAGE	4 /27

1. GENERAL SPECIFICATIONS

1-1.DESCRIPTION:

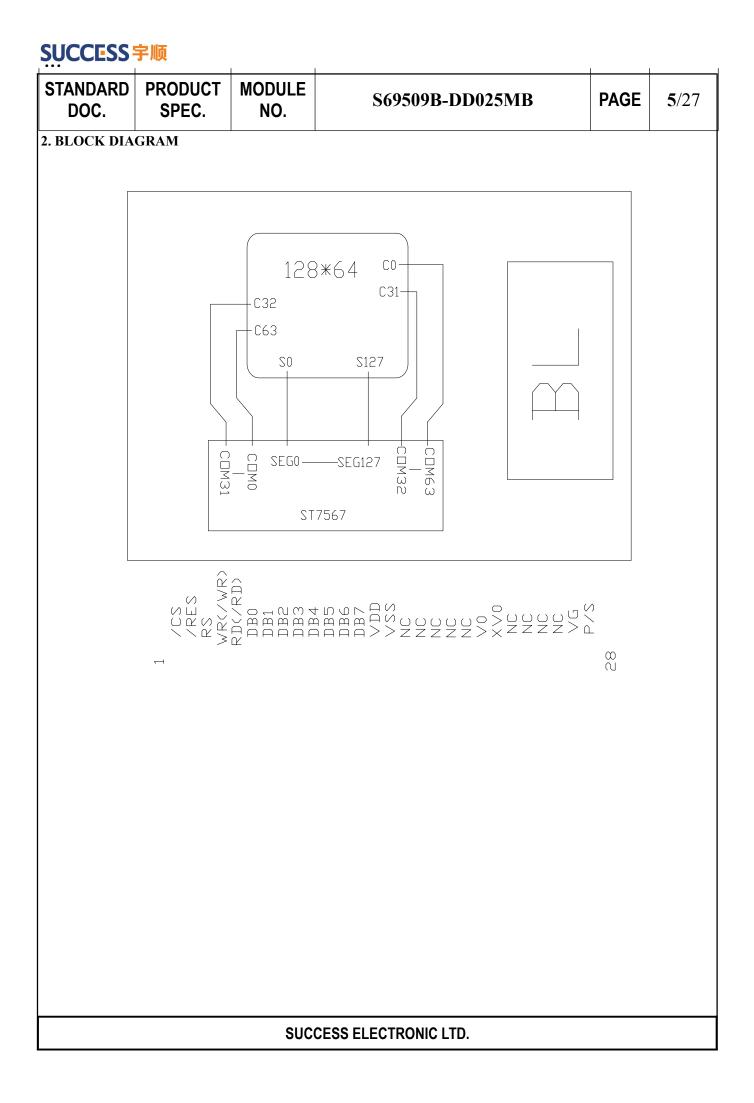
The S69509B-DD025MB is a dot matrix mono Liquid Crystal Display Module(LCM). This specification covers the delivery requirements for the liquid crystal display delivered by SUCCESS ELECTRONIC to Customer.

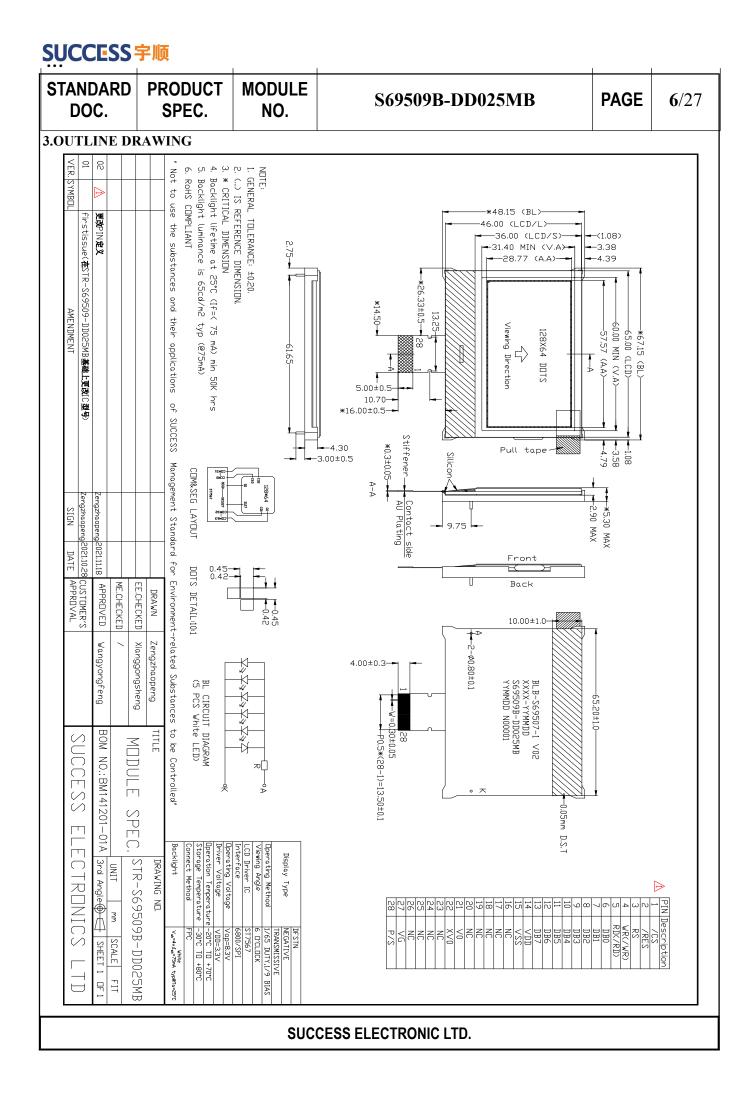
1-2. FEATURES

- (1) Display Type: DFSTN, Negative, Transmissive, 6O'clock
- (2) Driving Method: VDD=3.3V, 1/65 duty, 1/9 bias
- (3) Built-in controller: ST7567
- (4) With White Backlight

1-3.GENERAL SPECIFICATION

ITEM	SPECIFICATIONS	UNIT
DISP.CONSTRUCTION	128*64 Dots	
OUTLINE DIMEMSIONS	67.15(W)*48.15(H)*5.30(T)(Not Included FPC)	mm
VIEWING AREA	60.00(W) x31.40(H)	mm
ACTIVE AREA	57.57(W) x 28.77(H)	mm
DOT SIZE	0.42(W) x 0.42(H)	mm
DOT PITCH	0.45(W) x 0.45(H)	mm
ASSY.TYPE	COG+FPC+BL	
INTERFACE	6800/SPI	
BACKLIGHT	White	



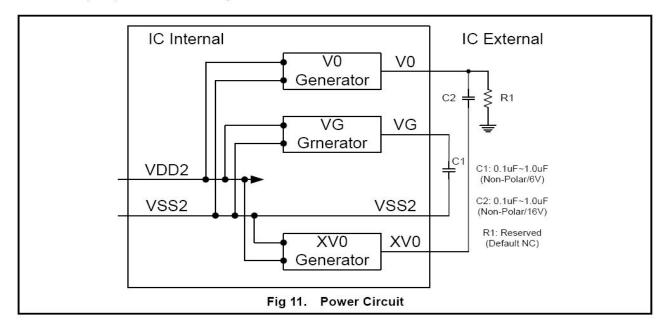


STANDARD DOC.	PRODUCT SPEC.	MODULE NO.	S69509B-DD025MB	PAGE	7/2
INTERFAC	E ASSIGNMENT	I			
1	Chip select input p	oin		/CS	
2	Reset input pin			/RE	S
3	Data/instruction se	election pin		RS	
	Read/Write signal	select			
4	When $R/W = "H$	When $R/W = "H"$: Read W			
	When $R/W = "L$	": Write			
5	Enable signal, star	Enable signal, start data read/write			
6~13	8 bit data Bus Line	2		DB)~DB7
14	Logic power suppl	ly, +3.3V		VD]	D
15	Ground, 0V			VSS	5
16~20	NO CONNECT			NC	
21	V0 is the LCD dri	ving voltage for co	ommon circuits at negative frame	V0	
22	XV0 is the LCD d	riving voltage for	common circuits at positive frame.	XV	0
23~26	NO CONNECT			NC	
27	VG is the LCD dri	ving voltage for se	egment circuits	VG	
28	This pin configure	s the interface to p	arallel mode or serial mode.	P/S	

STANDARD
DOC.PRODUCT
SPEC.MODULE
NO.S69509B-DD025MBPAGE

5.APPLICATION CIRCUIT

The recommended external power components need only 2 capacitors. The detailed values of these two capacitors are determined by the panel size and loading.



Regulator Circuit

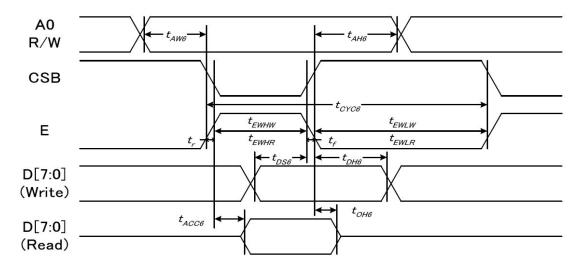
The built-in high accuracy regulation circuit has 8 regulation ratios and each one has 64 EV-levels for voltage adjustment. Without additional external component, the output voltage can be changed by instructions such as "Regulation Ratio" and "Set EV". The detailed setting method can be found in the INSTRUCTION DESCRIPTION section.

SUCCESS宇顺 STANDARD PRODUCT MODULE S69509B-DD025MB DOC. SPEC. NO.

6. TIMING CHARACTERISTICS

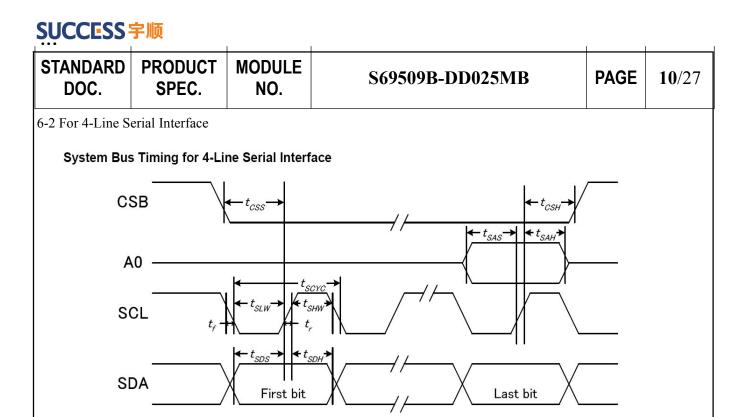
6-1 For the 6800 series MPU(Default Mode)

System Bus Timing for 6800 Series MPU



				(VDD	01 = 3.3V , [−]	Γa =25°C)
ltem	Signal	Symbol	Condition	Min.	Max.	Unit
Address setup time	AO	tAW6		0	.—	
Address hold time	AU	tAH6		10	-	
System cycle time		tCYC6		240	—]
Enable L pulse width (WRITE)		tEWLW		80]
Enable H pulse width (WRITE)	E	tEWHW		80	—	
Enable L pulse width (READ)		tEWLR		80		ns
Enable H pulse width (READ)		tEWHR		140]
Write data setup time		tDS6		40	-	
Write data hold time	D[7:0]	tDH6		10	_]
Read data access time	D[7:0]	tACC6	CL = 16 pF		70]
Read data output disable time		tOH6	CL = 16 pF	5	50	

				(VDE	01 = 2.8∨ , [−]	Ta =25 C
ltem	Signal	Symbol	Condition	Min.	Max.	Unit
Address setup time	A0	tAW6		0	-	
Address hold time	AU	tAH6		0	_	
System cycle time		tCYC6		400	-	
Enable L pulse width (WRITE)		tEWLW		220	-	
Enable H pulse width (WRITE)	E	tEWHW		180]
Enable L pulse width (READ)		tEWLR		220		ns
Enable H pulse width (READ)		tEWHR		180		
Write data setup time		tDS6		40]
Write data hold time	D/7-01	tDH6		20]
Read data access time	D[7:0]	tACC6	CL = 16 pF		140	
Read data output disable time		tOH6	CL = 16 pF	10	100	1



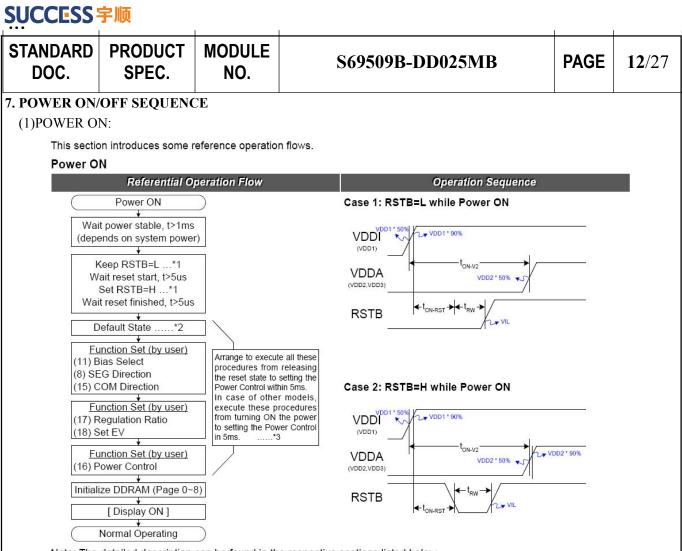
				(VDL)1 = 3.3V , ⁻	la =25 C)
Item	Signal	Symbol	Condition	Min.	Max.	Unit
Serial clock period		tSCYC		50		
SCLK "H" pulse width	SCLK	tSHW		25		
SCLK "L" pulse width		tSLW		25		
Address setup time		tSAS		20		
Address hold time	A0	tSAH		10		ns
Data setup time	004	tSDS		20		
Data hold time	SDA	tSDH		10		
CSB-SCLK time	000	tCSS		20		
CSB-SCLK time	CSB	tCSH		40		1

(VDD1	= 2.8V	, Ta	=25°C)
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0 = ° 0 1

ltem	Signal	Symbol	Condition	Min.	Max.	Unit
Serial clock period		tSCYC		100		
SCLK "H" pulse width	SCLK	tSHW		50		
SCLK "L" pulse width		tSLW		50	_	
Address setup time		tSAS		30		
Address hold time	A0	tSAH		20		ns
Data setup time	SDA	tSDS		30		
Data hold time	SDA	tSDH		20		
CSB-SCLK time	CSB	tCSS		30		
CSB-SCLK time	CSB	tCSH		60	_	

TANDARD DOC.	PRODUCT SPEC.	MODULE NO.	S69509B-DD02	25MB	PAGE	E 11/2 ⁷
3 RESET INPU	JT TIMING					
Hardware Res	set Timing					
RST	в	t _{RW}				
Inter Stat	V	Du	ing Reset	Reset Fini	shed	
				(VDD	I = 3.3∀ , Ta =	
Desetting	ltem	Sym		Min.		Unit
Reset time Reset "L" pulse	width	tF tR\		1.0	1.0	us
Item Reset time Reset "L" pulse width		Sym tF		Min. 	I = 2.8∨ , Ta = Max. I 2.0	us
					I = 1.8V , Ta =	=25°C)
	Item	Sym	condition	Min.	Max. I	Unit
Reset time		tF			3.0	us
Reset "L" pulse	width	tR	v	3.0		uo



Note: The detailed description can be found in the respective sections listed below.

- 1. Please refer to the timing specification of t_{RW} and $t_{\text{R}}.$
- 2. Refer to Section RESET CIRCUIT.
- 3. The 5ms requirement depends on the characteristics of LCD panel and the external component of the power circuit. It is recommended to check with the real products with external component.
- 4. The detailed instruction functionality is described in Section 9. INSTRUCTION DESCRIPTION;
- 5. Power stable is defined as the time that the later power (VDDI or VDDA) reaches 90% of its rated voltage.

Timing	Requirement:
--------	--------------

Item	Symbol	Requirement	Note
VDDA power delay	ton-v2	0 ≤ t _{ON-V2}	• Applying VDDI and VDDA in any order will not damage IC.
RSTB input time	ton-rst	No Limitation	 If RSTB is Low, High or unstable during power ON, a successful hardware reset by RSTB is required after VDDI is stable. RSTB=L can be input at any time after power is stable. t_{RW} & t_R should match the timing specification of RSTB. To prevent abnormal display, the recommended timing is: 0 ≤ t_{ON-RST} ≤ 30 ms.

The requirement listed here is to prevent abnormal display on LCD module.

STANDARD DOC.

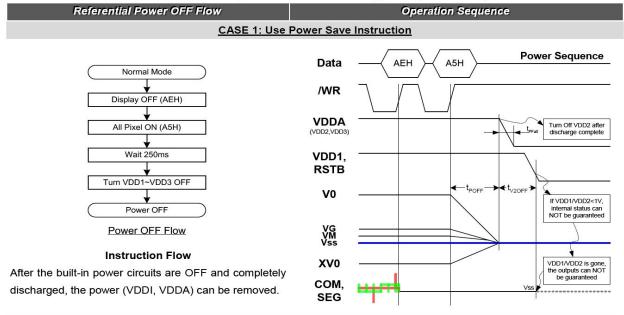
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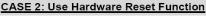
S69509B-DD025MB

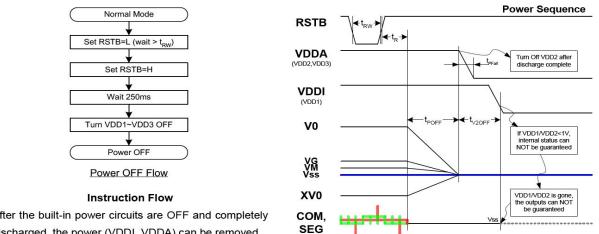
(2)POWER OFF:

Power OFF Flow and Sequence

In power save mode, LCD outputs are fixed to VSS and all analog outputs are discharged. The power can be turned OFF after ST7567 is in the power save mode. The power save mode can be triggered by the following two methods.







After the built-in power circuits are OFF and completely discharged, the power (VDDI, VDDA) can be removed. Note:

- tPOFF: Internal Power discharge time. => 250ms (max). 1.
- tv2OFF: Period between VDDI and VDDA OFF time. => 0 ms (min). 2.
- 3. It is NOT recommended to turn VDDI OFF before VDDA. Without VDDI, the internal status cannot be guaranteed and internal discharge-process maybe stopped. The un-discharged power maybe flows into COM/SEG output(s) and the liquid crystal in panel maybe polarized.
- 4. IC will NOT be damaged if either VDDI or VDDA is OFF while another is ON.
- The timing is dependent on panel loading and the external capacitor(s). 5.
- 6. The timing in these figures is base on the condition that: LCD Panel Size = 1.4" with C1=1uF, C2=1uF.
- 7. When turning VDDA OFF, the falling time should follow the specification: $20ms \le t_{Pfall} \le 0.2sec$

SUCCESS字顺 **STANDARD** PRODUCT MODULE S69509B-DD025MB PAGE 14/27 DOC. SPEC. NO. 8. RECOMMENDED INITIAL CODES void Initial(void) { CS=0; RES=1; DelayuS(5000); DelayuS(5000); RES=0; RES=1; DelayuS(5000); writec(0xe2); DelayuS(3); // RESET writec(0xa2); DelayuS(3); // 1/9 bias writec(0xa0); DelayuS(3); //ADC select , Normal writec(0xc8); DelayuS(3); //Common output reverse writec(0xf8); DelayuS(3); //4 booster writec(0x00); DelayuS(3); writec(0x24); DelayuS(3); // internal resistor ratio writec(0x81); DelayuS(3); //electronic volume mode set DelayuS(3); // electronic volume writec(28); writec(0x2c); DelayuS(1000); //Power Control1 writec(0x2e); DelayuS(1000); //Power Control2 writec(0x2f); DelayuS(1000); //Power Control3 writec(0x40); //Set Start Line DelayuS(3); writec(0xaf); DelayuS(3); // display ON }

STANDARD PRODUCT DOC. SPEC.

MODULE

NO.

S69509B-DD025MB

PAGE 15/27

9.INSTRUCTION TABLE

INSTRUCTION	A0	R/W			C	OMMA	ND BYT	E			DESCRIPTION	
INSTRUCTION	AU	(RWR)	D7	D6	D5	D4	D3	D2	D1	D0	DESCRIPTION	
(1) Display ON/OFF	0	0	1	0	1	0	1	1	1	D	D=1, display ON D=0, display OFF	
(2) Set Start Line	0	0	0	1	S5	S4	S3	S2	S1	SO	Set display start line	
(3) Set Page Address	0	0	1	0	1	1	Y3	Y2	Y1	Y0	Set page address	
(4)	0	0	0	0	0	1	X7	X6	X5	X4	Set column address (MSB)	
Set Column Address	0	0	0	0	0	0	X3	X2	X1	X0	Set column address (LSB)	
(5) Read Status	0	1	0	MX	D	RST	0	0	0	0	Read IC Status	
(6) Write Data	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write display data to RAM	
(7) Read Data	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read display data from RAM	
(8) SEG Direction	0	0	1	0	1	0	0	0	0	MX	Set scan direction of SEG MX=1, reverse direction MX=0, normal direction	
(9) Inverse Display	0	0	1	0	1	0	0	1	1	INV	INV =1, inverse display INV =0, normal display	
(10) All Pixel ON	0	0	1	0	1	0	0	1	0	AP	AP=1, set all pixel ON AP=0, normal display	
(11) Bias Select	0	0	1	0	1	0	0	0	1	BS	Select bias setting 0=1/9; 1=1/7 (at 1/65 duty)	
(12) Read-modify-Write	0	0	1	1	1	0	0	0	0	0	Column address increment: Read:+0 , Write:+1	
(13) END	0	0	1	1	1	0	1	1	1	0	Exit Read-modify-Write mode	
(14) RESET	0	0	1	1	1	0	0	0	1	0	Software reset	
(15) COM Direction	0	0	1	1	o	0	MY	-	-	ā	Set output direction of COM MY=1, reverse direction MY=0, normal direction	
(16) Power Control	0	0	0	0	1	0	1	VB	VR	VF	Control built-in power circuit ON/OFF	
(17) Regulation Ratio	0	0	0	0	1	0	0	RR2	RR1	RR0	Select regulation resistor ratio	
	0	0	1	0	0	0	0	0	0	1	Double command!! Set	
(18) Set EV	0	0	0	0	EV5	EV4	EV3	EV2	EV1	EV0	electronic volume (EV) level	
	0	0	1	1	1	1	1	0	0	0	Double command	
(19) Set Booster	0	0	0	0	0	0	0	0	0	BL	Set booster level: BL=0: 4X BL=1: 5X	
(20) Power Save	0	0	4 ^m		Coi	npound	Comm	and			Display OFF + All Pixel ON	
(21) NOP	0	0	1	1	1	0	0	0	1	1	No operation	
(22) Test	0	0	1	1	1	1	1	1	1	TE	Test Command Moe TE=0: releasing test command mode TE=1: entering test command mode	

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MODULE NO.

S69509B-DD025MB

10.ELECTRICAL CHARACTERISTICS

10-1 Absolute maximum ratings

ITEM	SVMDOI	STA	UNIT		
I I EM	SYMBOL	MIN	ТҮР	MAX	UNIT
SUPPLY VOLTAGE FOR LOGIC	VDD	-0.3		4	V
LCD POWER SUPPLY VOLTAGE	V0-XV0	-0.3		16	V
OPERATING TEMPERATURE	Тор	-20		70	°C
STORAGE TEMPERATURE	T _{STG}	-30		80	°C

10-2 Electrical characteristics

ITEM	SYMBOL	CONDITIONS		ALUE	UNIT	
	STMBOL	CONDITIONS	MIN	ТҮР	MAX	UNII
SUPPLY VOLTAGE FOR LOGIC	VDD		3.2	3.3	3.4	V
SUPPLY VOLTAGE FOR LCD	V0-XV0		8.1	8.3	8.5	V
INPUT VOLTAGE "H" LEVEL	VIH		0.7VDD	-	VDD	V
INPUT VOLTAGE "L" LEVEL	VIL		VSS	-	0.3VDD	V
OUTPUT VOLTAGE "H" LEVEL	VOH	Ta= 25 ℃	0.8VDD	-	VDD	v
OUTPUT VOLTAGE "L" LEVEL	VOL		VSS	-	0.2VDD	V
CURRENT CONSUMPTION (CHECKER)	IDD		-	0.5	1.0	mA
POWER CONSUMPTION (CHECKER)	РС		-	1.65	3.3	mW

SUCCESS宇顺 STANDARD PRODUCT MODULE PAGE S69509B-DD025MB 17/27DOC. SPEC. NO. **11. LED BACKLIGHT** 11-1 LED CIRCUIT: ÷А R $\langle x \rangle \langle x$ θK 11-2.ABSOLUTE MAXIMUN RATING

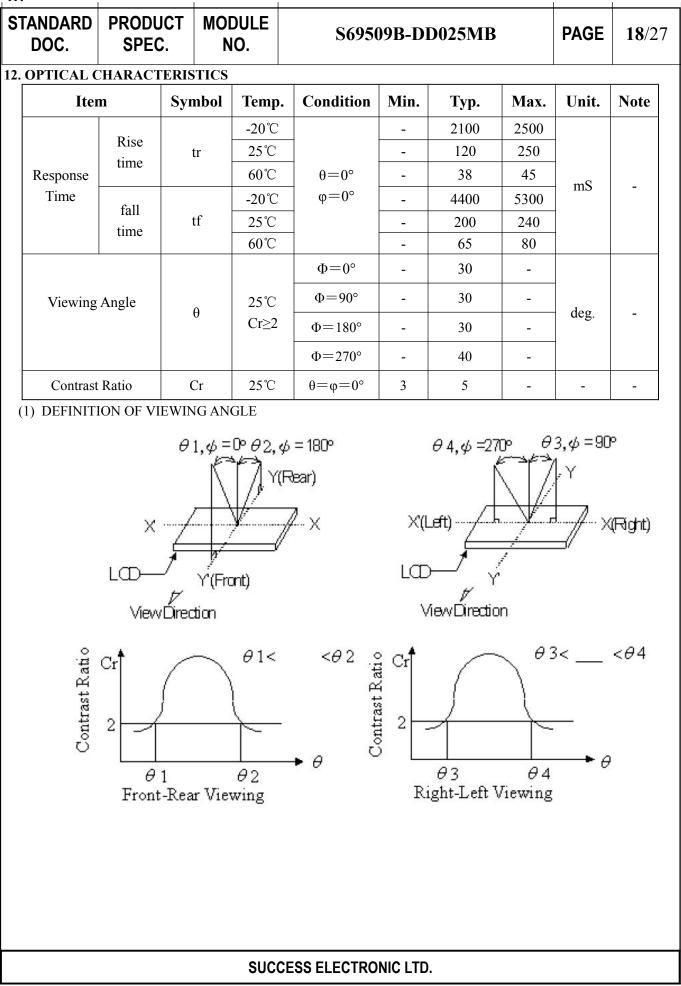
PARAMETER	SYMBOL	SPECIFICATIONS	UNIT
POWER DISSIPATION	PD	400	mW
FORWARD CURRENT	Ifm	100	mA
PEAK FORWARD CURRENT	Ifp	300	mA
REVERSE VOLTAGE	Vr	5	V
OPERATION TEMPERATURE	TOPR	-20℃~+70℃	°C
STORAGE TEMPERATURE	TSTG	-30°C~+80°C	°C

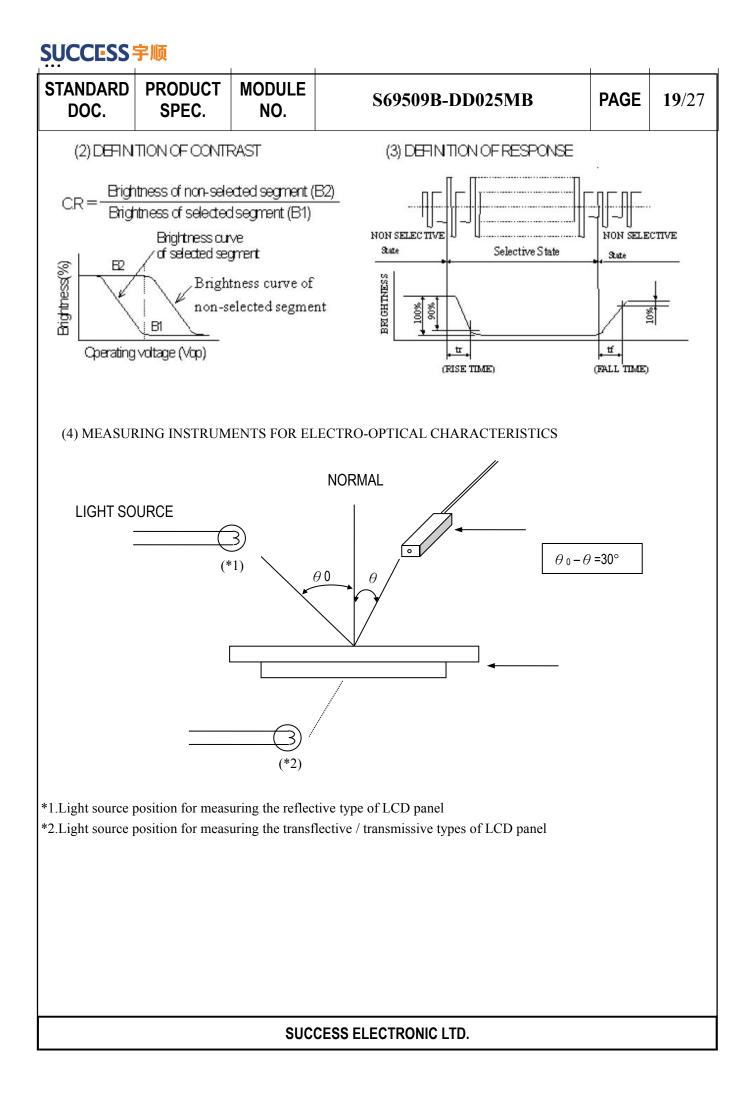
11-3. ELECTRICAL CHARACTERISTICS (Ta=25°C)

PARAMETER	SYMBOL	LIGHT	CONDITIONS	STANI	UNIT		
		SOURCE		MIN	ТҮР	MAX	
FORWARD CURRENT	If		Vak=4.0V	-	75	100	mA
REVERSE CURRENT	IR	White	Vr= 5V/LED	-	-	10	uA
BL BRIGHTNESS	Lv		Vak=4.0V	800	1000	-	cd/m ²
CIE Color	Х		Vak=4.0V	0.24	0.27	0.30	-
Coordinate(without LCD)	Y		Vak=4.0V	0.24	0.27	0.30	-
LUMINOUS UNIFORMITY	Δ		Vak=4.0V	75%	-	-	%.

Note: Uniformity Δ =(minmum LV/maximum LV)*100%.

For operation above 25 °C, The Ifm、 Ifp & PD must be derated ,the Current derating is -0.36mA/°C for Dc drive and-0.9mA/°C for pulsr drive,the power dissipation is -1.08 mW/°C, The product working current must not more than the 60 % of the Ifp according to the working temperature.





STANDARD DOC.

MODULE NO.

S69509B-DD025MB

13. ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS

ITEM	SYMBOL	CONDITIONS	CRITERION
ODED ATINIC TEMPED ATUDE	TOPR	-20°C ~+70°C	NO DEFECT IN DISPLAYING AND
OPERATING TEMPERATURE	TOPK	$-20 C \sim +70 C$	OPERATIONAL FUNCTION
STODACE TEMPEDATURE	TOTO	-30°C ~+80°C	NO DEFECT IN DISPLAYING AND
STORAGE TEMPERATURE	TSTG	$-30 C \sim +80 C$	OPERATIONAL FUNCTION
HUMIDITY	—	See Note	WITHOUT CONDENSATION

Note: Test condition:

1) Temperature and humidity: if no specification, temperature set at $25+/-2^{\circ}$ C, and humidity set at 60+/-5% RH.

2)Operating state: all the tests to which the samples subject should be in operating condition.

14. RELIABILITY TEST

ITEM	CONDITIONS	CRITERION
Operating	HIGH TEMPERTURE 70°C 120HRS	No defect in displaying and operational
Temperature	LOW TEMPERTURE -20°C 120HRS	function
Storage	HIGH TEMPERTURE +80°C 120HRS	No defect in displaying and operational
Tempereature	LOW TEMPERTURE -30°C 120HRS	function
High Humidity &	40℃* 90%RH 120HRS	No defect in displaying and operational
high Temp	40 C 90/0KH 120HKS	function
	• Operating Time: 30 minutes exposure for	
Vibration	each direction (X,Y,Z)	No defect in displaying and operational
VIDIATION	• Sweep Frequency: $10 \sim 55$ Hz (1 min)	function
	• Amplitude: 1.5mm	
Thermal Shock	$-20^{\circ}C(30 \text{ mins}) \leftrightarrow +70^{\circ}C(30 \text{ mins}) 50 \text{ cycles}$	No defect in displaying and operational
Thermal Shock	-20 $C(300000) \subset 2 \pm 70 C(300000) 30 Cycles$	function

STANDARDPRODUCTMODULEDOC.SPEC.NO.

S69509B-DD025MB

PAGE 21/27



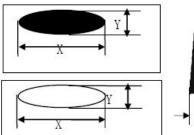
15-1 SAMPLING PLAN

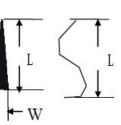
Unless there is other agreement, sampling plan for incoming inspection should follow GB2828-2003.

15-1-1 Lot size: Quantity per shipment as one lot (different model as different lot .)

15-1-2 Sampling type: Normal inspection, single sampling.

- 15-1-3 Sampling level: Level II.
- 15-1-4 Acceptable Quality Level Major defect: AQL=0.40 Minor defect: AQL=0.65 Total defect : AQL=0.65





15-2 PANEL INSPECTION CONDITION

- 15-2-1 Environment:Room Temperature: 25±5°C.Humidity: 55±5% RH.Illumination:800~1200Lux.
- 15-2-2 Inspection Distance: 25 ± 5 cm from the inspector to the module.
- 15-2-3 Inspection Angle: The vision of inspector should be perpendicular to the surface of the module.

16-3 MODULE INSPECTION STANDARDS

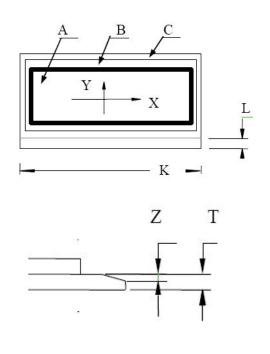
- 16-3-1 Defect definition
- MAJOR:display or functional defects, serious deviation from the specifications, customers can not work properly; Severe skin defects, serious deviation from the specifications, the client does not work properly.
- MINOR: slightly deviate from the specifications, does not affect the product function, but the appearance of an impact on product
 - Note: The following standard if no entities are specified, with mm meter.
- 15-3-2 Product area and size code definition

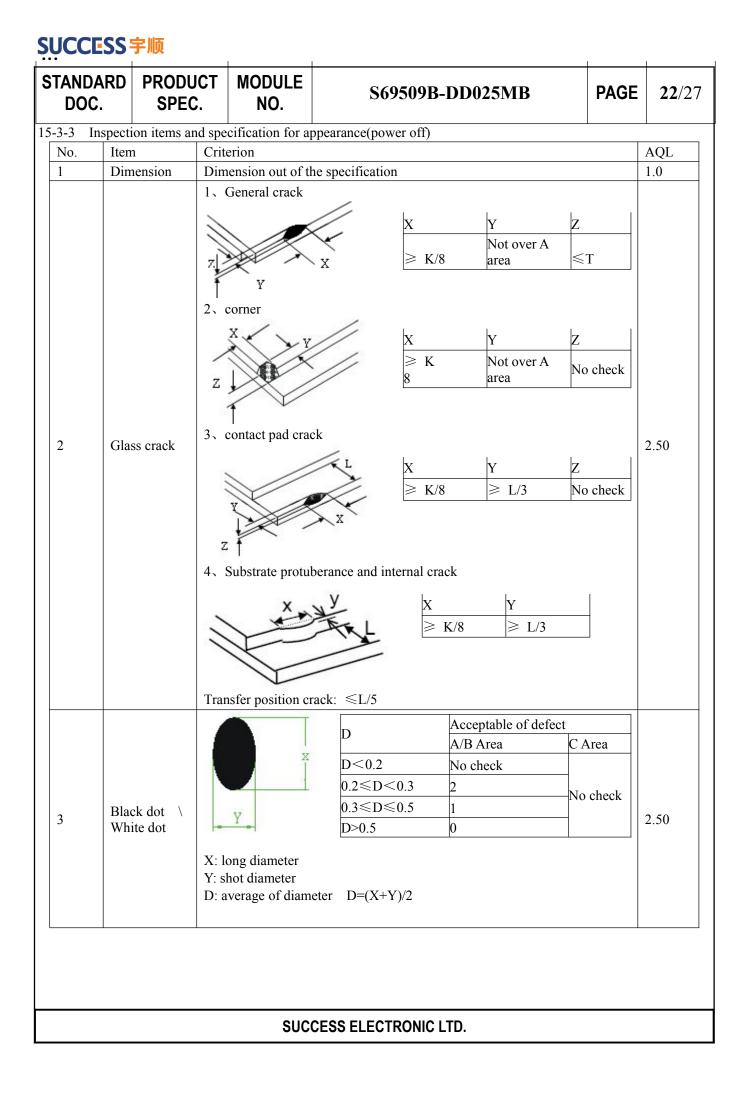
A area: said display active area(characters display)

- B area: says visual area (except A area)
- C area: the unvisual areas.
- T: it says he thickness of the single glass
- L: said glass pin lengths
- K: said product length
- X :said glass long side direction or glass edge direction along the length of the gap
- Y :said glass short side direction or gap with glass edge along the vertical length
- Z: the thickness of crack or gap

point:
$$\Phi = (X + Y) / 2$$

The length of the X says point length; Y says point width Line:L says the length of the line; W says line width





TAND DOC		PRODU SPEC)dule No.	S	69509B-1	DD025MB		PAGE	23 /27
4	Line d	lefect	L: Length Defect of		accept $L \leq 3$ $L \leq 2.5$ dth	hidth W≤0.02 W≤0.05 W≥0.05	Acceptable A/B Area No check 2 2 As round ty	C A	check	2.50
5	Polari Bubbl		У	X	D $D \leq 0.2$ $0.2 \leq D \leq$ $0.5 \leq D \leq$ $D > 1.0$		Acce table of defect A/B Area No check 3 2	C Area		2.50
6	Exterr of pan	nal print iel			ole: same a		×			2.50
7	Silicon	n glue	The area	of paintin	g silicon glu	e must cover	the ITO circuit.			2.50
8	Defec PCB	t of	are unrec	eivable fo	or PCB.	-	wit, crack and air		orifice	2.50
9	SMT	organ	Trying to	keep dot	onent≤1/3w of soldering wrong asse	tin orbicular		ble for		2.50
10	Steel I	Frame	Break and If there is that follo	d distortio one nick wing:	n are unrece which can n Width≤0.31	ot lead to ca	ame. st or hole of painti	ing, we	allow	2.50
15-3-4	Inspectio	on items a	nd specific	cation for	display defe	ct(power on))			
				Segm	ent missing	Not allow				

		SUCCESS ELEC	TRONIC LTD.		
1	Electrical Defect	Segment s ort	Not allow Not allow	1.0	
	Segment missing	Not allow			

STANDA DOC			MODULE NO.		S69509B-DD	025MB	PAGE	24 /27
2	Pin hole		Pin hole	× TB	V = (A+B) /2	Acceptable of $D \le 0.2 \& D$ $D \le 0.25 \& I$ $D \le 0.1 \ acceptone between the second se$	$\leq 1/2W$ $D \leq 1/3W$	2.50
3	Display pattern	W: I	Design dimensi	V	Vidth V<0.4 V≥0.4 D: discrepant dime	Acceptable of $C, D, G \leq$ $C, D, G \leq$ ension $G= E-F $	1/2W 0.2	1.0
4	Black/white dot	Y: s	y y ong diameter hot diameter verage diamete	0 0 1	$\begin{array}{c} 0 \\ 0 < 0.1 \\ .1 \leq D < 0.2 \\ .2 \leq D \leq 0.25 \\ 0 > 0.25 \end{array}$	No check	Y C Area No check	2.50
5	Line defect			Length 不计 L≤3 L≤2.5	Width W ≤ 0.02 W ≤ 0.03 0.03 < W < 0.05	No check	C Area No check	2.50

16. USING LCD MODULES

16-1 LIQUID CRYSTAL DISPLAY MODULES

LCD is composed of glass and polarizer. Pay attention to the following items when handling.

(1) Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

STANDARDPRODUCTMODULES69509B-DD025MBPAGE25DOC.SPEC.NO.	-			S69509B-DD025MB	PAGE	25 /27
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(2) Do not touch, push or rub the exposed polarizer with anything harder than an HB pencil lead (glass, tweezers, etc.).

- (3) N-hexane is recommended for cleaning the adhesives used to attach front/rear polarizers and reflectors made of organic substances which will be damaged by chemicals such as acetone, toluene, ethanol and isopropylalcohol.
- (4) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, wipe gently with absorbent cotton or other soft material like chamois soaked in Isopropyl alcohol or Ethyl alcohol. Do not scrub hard to avoid damaging the display surface.
- (5) Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading.
- (6) Avoid contacting oil and fats.
- (7) Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizers. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- (8) Do not put or attach anything on the display area to avoid leaving marks on.
- (9) Do not touch the display with bare hands. This will stain the display area and degradate insulation between terminals (some cosmetics are determinated to the polarizers).
- (10) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- (11) As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring.

16-2 PRECAUTION FOR HANDING LCD MODULES

- Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (1) Do not alter, modify or change the the shape of the tab on the metal frame.
- (2) Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- (3) Do not damage or modify the pattern writing on the printed circuit board.
- (4) Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- (5) Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- (6) Do not drop, bend or twist LCM. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- (7) In order to avoid the cracking of the FPC, you should to pay attention to the area of FPC where the FPC was
- bent .the edge of coverlay; the area of surface of Ni-Au plating, the area of soldering land, the area of through hole.

16-3 ELECTRO-STATIC DISCHARGE CONTROL

Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC.

STANDARD
DOC

PRODUCT SPEC.

MODULE

NO.

S69509B-DD025MB

- Make certain that you are grounded when handing LCM. To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules. - Exposed area of the printed circuit board. - Terminal electrode sections.
- (2) Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential.
- (3) When soldering the terminal of LCM, make certain the AC power source for the soldering iron does not leak.
- (4) When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.

(5) As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.

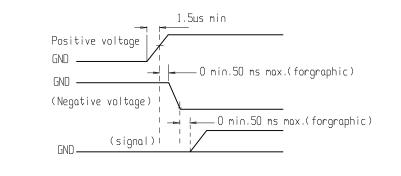
(6) To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended.

16-4 PRECAUTIONS FOR OPERATION

(1) Viewing angle varies with the change of liquid crystal driving voltage (VO). Adjust VO to show the best contrast.

(2) Driving the LCD in the voltage above the limit shortens its life.

- (3) If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- (4) Response time is greatly delayed at temperature below the operating temperature range. However, this does not mean the LCD will be out of the order. It will recover when it returns to the specified temperature range.
- (5) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- (6) Condensation on terminals can cause an electrochemical reaction disrupting the terminal circuit. Therefore, it must be used under the relative condition of 40°C , 50% RH.
- (7) When turning the power on, input each signal after the positive/negative voltage becomes stable.



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16-5 STORAGE

When storing LCDs as spares for some years, the following precaution are necessary.

(1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for dessicant.

(2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0° C and 35° C.

3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped.)

- (4) Environmental conditions :
 - Do not leave them for more than 180hrs. at 70°C.
 - Should not be left for more than 48hrs. at -20°C.

16-6 SAFETY

- (1) It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- (2) If any liquid leakes out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

14-7 LIMITED WARRANTY

Unless agreed between SUCCESS and customer, SUCCESS will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with SUCCESS LCD acceptance standards (copies available upon request) for a period of one year from date of shipments. Cosmetic/visual defects must be returned to SUCCESS within 90 days of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of SUCCESS limited to repair and/or replacement on the terms set forth above. SUCCESS will not be responsible for any subsequent or consequential events.

16-8 RETURN LCM UNDER WARRANTY

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

- Broken LCD glass.

- Circuit modified in any way, including addition of components.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB's eyelet, conductors and terminals.